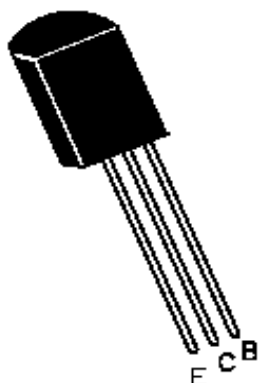


## NPN EPITAXIAL PLANAR SILICON TRANSISTOR

CD1207

TO-92L  
Plastic Package



### High Curreent Switching Applications

#### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Base Voltage	$V_{CBO}$	60	V
Collector Emitter Voltage	$V_{CEO}$	50	V
Emitter Base Voltage	$V_{EBO}$	6	V
Collector Current	$I_C$	2	A
Peak Collector Current	$I_{CP}$	4	A
Collector Power Dissipation	$P_C$	1	W
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	- 55 to +150	$^\circ\text{C}$

#### ELECTRICAL CHARACTERISTICS ( $T_a=25^\circ\text{C}$ unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Base Voltage	$V_{CBO}$	$I_C=10\mu\text{A}$ , $I_E=0$	60			V
Collector Emitter Voltage	$V_{CEO}$	$I_C=1\text{mA}$ , $I_B=0$	50			V
Emitter Base Voltage	$V_{EBO}$	$I_E=10\mu\text{A}$ , $I_C=0$	6			V
Collector Cut Off Current	$I_{CBO}$	$V_{CB}=50\text{V}$ , $I_E=0$			100	nA
Emitter Cut Off Current	$I_{EBO}$	$V_{EB}=4\text{V}$ , $I_C=0$			100	nA
DC Current Gain	$*h_{FE}$	$I_C=100\text{mA}$ , $V_{CE}=2\text{V}$	100		560	
	$h_{FE}$	$I_C=1.5\text{A}$ , $V_{CE}=2\text{V}$	40			
Collector Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=1\text{A}$ , $I_B=50\text{mA}$			0.4	V
Base Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=1\text{A}$ , $I_B=50\text{mA}$			1.2	V

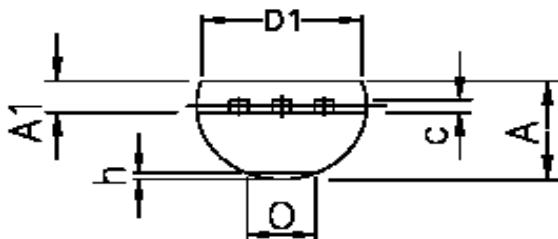
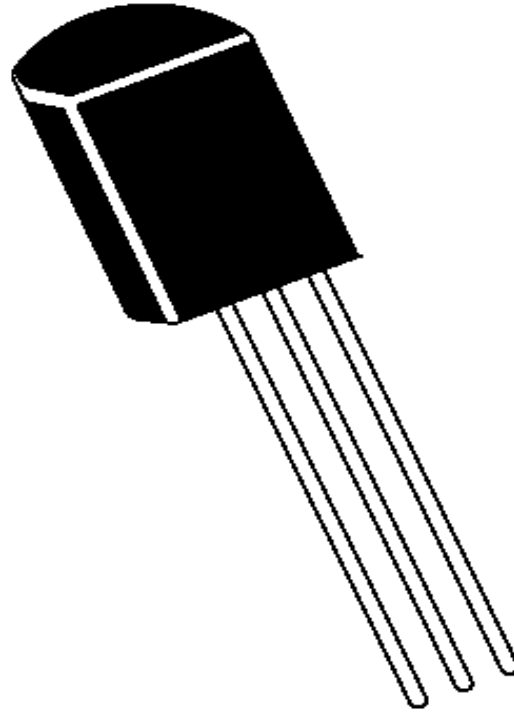
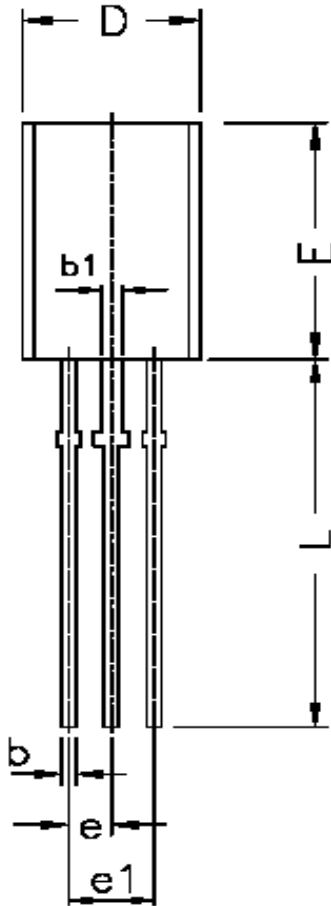
#### DYNAMIC CHARACTERISTICS

Transition Frequency	$f_T$	$V_{CE}=10\text{V}$ , $I_C=50\text{mA}$		150		MHz
Output Capacitance	$C_{ob}$	$V_{CB}=10\text{V}$ , $I_E=0$ , $f=1\text{MHz}$		12		pF

CLASSIFICATION	R	S	T	U
$*h_{FE}$	100 - 200	140 - 280	200 - 400	280 - 560

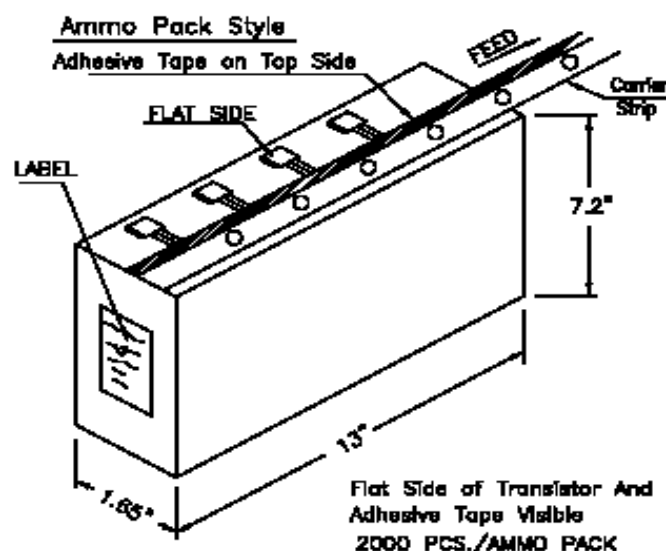
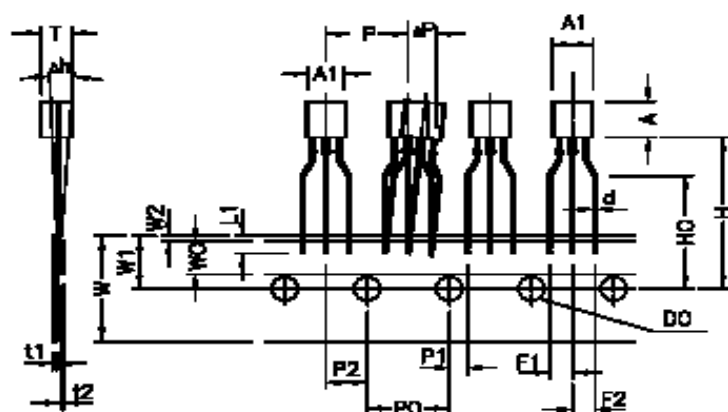
CD1207Rev140205E

## PACKAGE TO-92L



DIM	MIN	MAX
A	3.700	4.100
A1	1.280	1.580
b	0.350	0.550
b1	0.600	0.800
c	0.350	0.450
D	4.700	5.100
D1	4.000	—
E	7.800	8.200
e	1.270 TYP.	
e1	2.440	2.640
L	13.600	14.200
O	—	1.600
h	0.000	0.300

## TO-92L TRANSISTOR ON TAPE AND AMMO PACK



ITEM	SYMBOL	VALUE & TOLERANCE
BODY WIDTH	A1	4.9 ±0.2
BODY HEIGHT	A	8.0 ±0.2
BODY THICKNESS	T	3.9 ±0.2
LEAD WIRE DIAMETER	d	0.45 ±0.05
PITCH OF COMPONENT	P	12.7 ±0.3
FEED HOLE PITCH	P0	12.7 ±0.2
HOLE CENTER TO COMPONENT CENTER	P2	6.35 ±0.3
LEAD TO LEAD DISTANCE	F1, F2	2.5 ±0.3
COMPONENT ALIGNMENT, F-R	Δh	0 ±1.0
TYPE WIDTH	W	18.0 +1.0, -0.5
HOLE DOWN TAPE WIDTH	W0	6.0 ±0.5
HOLE POSITION	W1	9.0 ±0.5
HOLE DOWN TAPE POSITION	W2	1.0 MAX.
HEIGHT OF COMPONENT FROM TAPE CENTER	H	19.0 +2.0, -0
LEAD WIRE CLUNCH HEIGHT	H0	16.0 ±0.5
LEAD WIRE (TAPE PORTION)	L1	2.5 MIN
FEED HOLE DIAMETER	D0	4.0 ±0.2
TAPED LEAD THICKNESS	t1	0.4 ±0.05
CARRIER TAPE THICKNESS	t2	0.2 ±0.05
POSITION OF HOLE	P1	3.85 ±0.3
COMPONENT ALIGNMENT	ΔP	0 ±1.0

## NOTES:—

1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm
2. MAXIMUM NON-CUMULATIVE VARIATION BETWEEN TAPE FEED HOLES SHALL NOT EXCEED 1 mm IN 20 PITCHES.
3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS IS PERMITTED.
5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES IS REQUIRED AFTER THE LAST COMPONENT.
6. SPIKES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

### **Disclaimer**

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